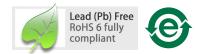
# HLMP-EGxx, HLMP-EHxx, HLMP-ELxx

New T-1¾ (5mm) Extra High Brightness AllnGaP LED Lamps



# **Data Sheet**



## Description

These Precision Optical Performance AllnGaP LEDs provide superior light output for excellent readability in sunlight and are extremely reliable. AllnGaP LED technology provides extremely stable light output over long periods of time. Precision Optical Performance lamps utilize the aluminum indium gallium phosphide (AllnGaP) technology.

These LED lamps are untinted, T-1¾ packages incorporating second generation optics producing well defined spatial radiation patterns at specific viewing cone angles.

These lamps are made with an advanced optical grade epoxy offering superior high temperature and high moisture resistance performance in outdoor signal and sign application. The maximum LED junction temperature limit of +130°C enables high temperature operation in bright sunlight conditions. The epoxy contains both uv-a and uv-b inhibitors to reduce the effects of long term exposure to direct sunlight.

#### **Benefits**

- Superior performance for outdoor environments
- Suitable for auto-insertion onto PC board

#### **Features**

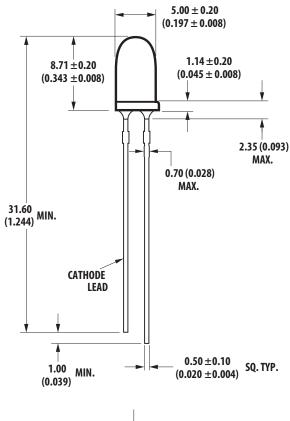
- Viewing angle: 15°, 23°, 30°
- High luminous output
- Colors:
  - 590nm Amber 615nm Red Orange 626nm Red
- Package options:
  - With or without lead standoff
- Superior resistance to moisture
- Untinted for 15°, 23° and 30° lamps

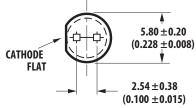
#### **Applications**

- Traffic management:
  - Traffic signals
  - Pedestrian signals
  - Work zone warning lights
  - Variable message signs
- Solar Power signs
- Commercial outdoor advertising
  - Signs
  - Marquees

# **Package Dimension**

## A: Non-standoff

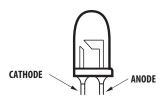


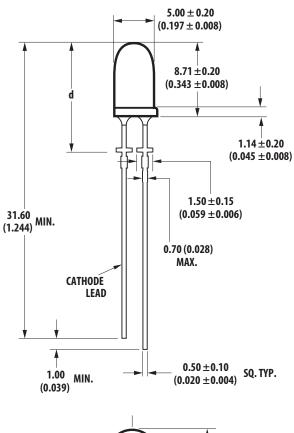


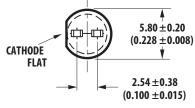
Viewing Angle	d
15°	12.39±0.25 (0.476±0.010)
23° & 30°	11.96±0.25 (0.459±0.010)

### Notes:

- 1. All dimensions are in millimeters (inches)
- 2. Leads are mild steel with tin plating.
- 3. The epoxy meniscus is 1.21mm max
- 4. For Identification of polarity after the leads are trimmed off, please refer to the illustration below:







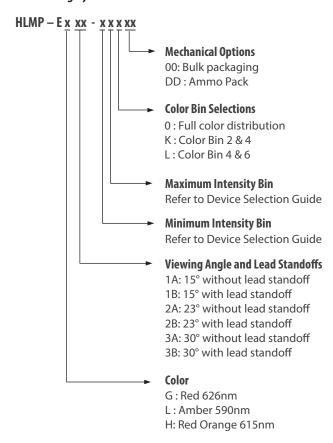
#### **Device Selection Guide**

Color and Dominant Wavelength (nm),	Lamps without Standoff on leads	Lamps with Standoff on leads	Luminous Intensity Iv (mcd) <sup>[1,2,5]</sup> at 20 mA	
Typ [3]	(Package drawing A)	(Package drawing B)	Min	Max
Amber 590	HLMP-EL1A-Z1Kxx	HLMP-EL1B-Z1Kxx	12000	21000
	HLMP-EL1A-Z1LDD	HLMP-EL1B-Z1LDD	12000	21000
Red 626	HLMP-EG1A-Z10xx	HLMP-EG1B-Z10DD	12000	21000
Red Orange 615	HLMP-EH1A-Z10DD	HLMP-EH1B-Z10DD	12000	21000
Amber 590	HLMP-EL2A-XYKxx	HLMP-EL2B-XYKxx	7200	12000
	HLMP-EL2A-XYLDD	HLMP-EL2B-XYLDD	7200	12000
Red 626	HLMP-EG2A-XY0xx	HLMP-EG2B-XY0xx	7200	12000
Red Orange 615	HLMP-EH2A-XY0DD	HLMP-EH2B-XY0DD	7200	12000
Amber 590	HLMP-EL3A-WXKxx	HLMP-EL3B-WXKxx	5500	9300
	HLMP-EL3A-WXLDD	HLMP-EL3B-WXLDD	5500	9300
Red 626	HLMP-EG3A-WX0xx	HLMP-EG3B-WX0xx	5500	9300
Red Orange 615	HLMP-EH3A-WX0xx	HLMP-EH3B-WX0DD	5500	9300
	Wavelength (nm), Typ [3]  Amber 590  Red 626  Red Orange 615  Amber 590  Red 626  Red Orange 615  Amber 590  Red 626	Wavelength (nm), Typ [3]         on leads (Package drawing A)           Amber 590         HLMP-EL1A-Z1Kxx           HLMP-EL1A-Z1LDD         HLMP-EG1A-Z10xx           Red 626         HLMP-EG1A-Z10xx           Red Orange 615         HLMP-EL2A-XYKxx           HLMP-EL2A-XYLDD         HLMP-EL2A-XYLDD           Red 626         HLMP-EG2A-XY0xx           Red Orange 615         HLMP-EH2A-XY0DD           Amber 590         HLMP-EL3A-WXKxx           HLMP-EL3A-WXLDD         HLMP-EG3A-WX0xx	Wavelength (nm), Typ [3]         on leads (Package drawing A)         on leads (Package drawing B)           Amber 590         HLMP-EL1A-Z1Kxx         HLMP-EL1B-Z1Kxx           HLMP-EL1A-Z1LDD         HLMP-EL1B-Z1LDD           Red 626         HLMP-EG1A-Z10xx         HLMP-EG1B-Z10DD           Red Orange 615         HLMP-EH1A-Z10DD         HLMP-EH1B-Z10DD           Amber 590         HLMP-EL2A-XYKxx         HLMP-EL2B-XYKxx           HLMP-EL2A-XYLDD         HLMP-EL2B-XYLDD           Red 626         HLMP-EG2A-XY0xx         HLMP-EG2B-XY0xx           Red Orange 615         HLMP-EH2A-XY0DD         HLMP-EH2B-XY0DD           Amber 590         HLMP-EL3A-WXKxx         HLMP-EL3B-WXKxx           HLMP-EL3A-WXLDD         HLMP-EL3B-WXLDD           Red 626         HLMP-EG3A-WXOxx         HLMP-EG3B-WXOxx	Wavelength (nm), Typ [3]         On leads (Package drawing A)         Iv (mcd) [1], (Package drawing B)         Min           Amber 590         HLMP-EL1A-Z1Kxx         HLMP-EL1B-Z1Kxx         12000           Red 626         HLMP-EG1A-Z10xx         HLMP-EG1B-Z10DD         12000           Red Orange 615         HLMP-EH1A-Z10DD         HLMP-EH1B-Z10DD         12000           Amber 590         HLMP-EL2A-XYKxx         HLMP-EL2B-XYKxx         7200           Red 626         HLMP-EG2A-XYUDD         HLMP-EL2B-XYLDD         7200           Red 626         HLMP-EG2A-XYOXX         HLMP-EG2B-XYOXX         7200           Red 67         HLMP-EH2A-XYODD         HLMP-EG2B-XYODD         7200           Red Orange 615         HLMP-EH2A-XYODD         HLMP-EL3B-WXKxx         5500           Amber 590         HLMP-EL3A-WXKxx         HLMP-EL3B-WXLDD         5500           Red 626         HLMP-EG3A-WXCxx         HLMP-EG3B-WXCxx         5500

#### Notes:

- 1. The luminous intensity is measured on the mechanical axis of the lamp package and it is tested with pulsing condition.
- 2. The optical axis is closely aligned with the package mechanical axis.
- 3. Dominant wavelength,  $\lambda_{dr}$  is derived from the CIE Chromaticity Diagram and represents the color of the lamp.
- 4.  $\theta_{\frac{1}{2}}$  is the off-axis angle where the luminous intensity is half the on-axis intensity.
- 5. Tolerance for each bin limit is  $\pm$  15%

## **Part Numbering System**



Note: Please refer to AB 5337 for complete information on part numbering system.

## **Absolute Maximum Ratings**

T<sub>J</sub> = 25°C

Parameter	Red/ Amber/ Red Orange	Unit
DC Forward Current [2]	50	mA
Peak Forward Current	100 [1]	mA
Average forward current	30	mA
Power Dissipation	120	mW
Reverse Voltage	5	V
Operating Temperature Range	-40 to +100	°C
Storage Temperature Range	-40 to +100	°C

#### Notes:

- 1. Duty Factor 30%, frequency 1KHz.
- 2. Derate linearly as shown in Figure 4

# **Electrical / Optical Characteristics**

 $T_J = 25^{\circ}C$ 

Parameter	Symbol	Min	Тур.	Max	Units	Test Conditions
Forward Voltage						I <sub>F</sub> = 20 mA
Amber/ Red / Red Orange	$V_{F}$	1.8	2.1	2.4	V	
Reverse Voltage	V <sub>R</sub>	5			V	I <sub>R</sub> = 100 μA
Dominant Wavelength [1]	$\lambda_{d}$				nm	I <sub>F</sub> = 20 mA
Amber		584.5	590.0	594.5		
Red		618.0	626.0	630.0		
Red Orange		612.0	615.0	619.0		
Peak Wavelength	λρεΑΚ				nm	Peak of Wavelength of
Amber			594			Spectral Distribution
Red			634			at $I_F = 20 \text{ mA}$
Red Orange			621			
Spectral Halfwidth	Δλ <sub>1/2</sub>				nm	
Amber			13			
Red			14			
Red Orange			14			
Thermal resistance	$R\theta_{J-PIN}$		240		°C/W	LED junction to anode lead
Luminous Efficacy [2]	ην				lm/W	Emitted Luminous Flux/
Amber			500			<b>Emitted Radiant Flux</b>
Red			200			
Red Orange			265			
Luminous Flux	Ф				mlm	$I_F = 20 \text{ mA}$
Amber			2100			
Red			2300			
Red Orange			2300			
Luminous Efficiency [3]	$\eta_{e}$				lm/W	<b>Emitted Luminous</b>
Amber			50			Flux/Electrical Power
Red			55			
Red Orange			55			
Thermal coefficient of $\lambda d$					nm/°C	$I_F = 20 \text{ mA}$ ;
Amber			80.0			$+25^{\circ}C \le T_{J} \le +100^{\circ}C$
Red			0.05			
Red Orange			0.07			

#### Notes:

- 1. The dominant wavelength,  $\lambda_d$  is derived from the CIE Chromaticity Diagram referenced to Illuminant E. Tolerance for each color of dominant wavelength is  $\pm$ 0.5nm.
- 2. The radiant intensity,  $I_e$  in watts per steradian, maybe found from the equation  $I_e = I_V / \eta_V$  where  $I_V$  is the luminous intensity in candela and  $\eta_V$  is the luminous efficacy in lumens/ watt.
- 3.  $\eta_e = \Phi_v / I_F \times V_F$  where  $\Phi_v$  is the emitted luminous flux,  $I_F$  is electrical forward current and  $V_F$  is the forward voltage.

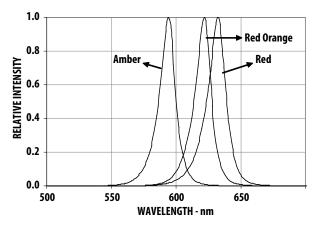


Figure 1. Relative Intensity vs Peak Wavelength

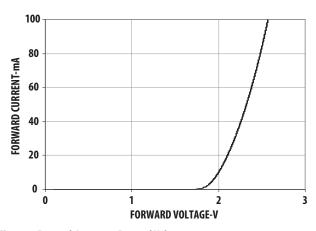


Figure 2. Forward Current vs Forward Voltage

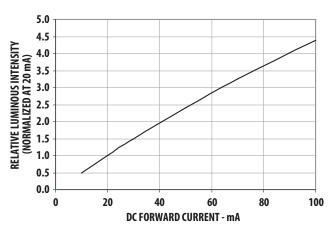


Figure 3. Relative Luminous Intensity vs Forward Current

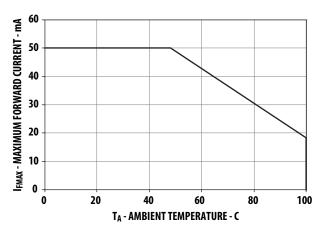


Figure 4. Maximum Forward Current vs Ambient Temperature

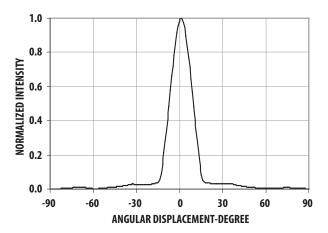


Figure 5.Radiation Pattern for 15° Viewing Angle Lamp

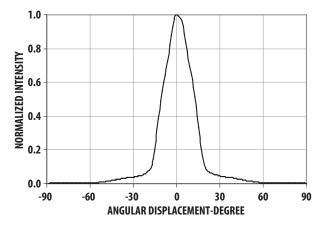


Figure 6. Radiation Pattern for 23° Viewing Angle Lamp

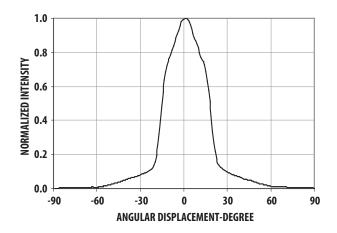
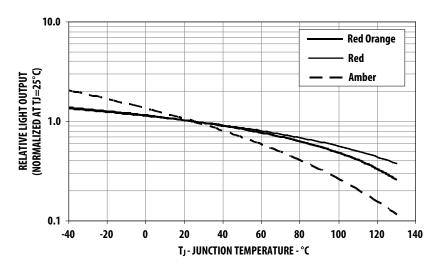
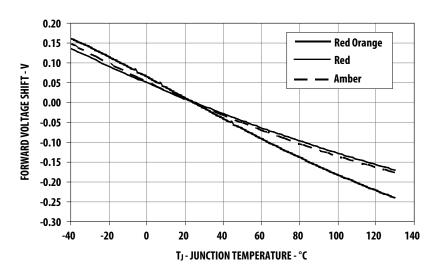


Figure 7. Radiation Pattern for 30° Viewing Angle Lamp

# **Relative Light Output vs Junction Temperature**



# **Relative Forward Voltage vs Junction Temperature**



# Intensity Bin Limit Table (1.3:1 lv bin ratio)

	Intensity (mcd)	Intensity (mcd) at 20mA		
Bin	Min	Max		
V	4200	5500		
W	5500	7200		
Χ	7200	9300		
Υ	9300	12000		
Z	12000	16000		
1	16000	21000		

Tolerance for each bin limit is  $\pm$  15%

# VF Bin Table (V at 20mA)

Bin ID	Min	Max	
VD	1.8	2.0	
VA	2.0	2.2	
VB	2.2	2.4	

Tolerance for each bin limit is  $\pm 0.05V$ 

# **Red Color Range**

Min	Max				
Dom	Dom	X min	Y Min	X max	Y max
618	630	0.6872	0.3126	0.6890	0.2943
		0.6690	0.3149	0.7080	0.2920

Tolerance for each bin limit is  $\pm 0.5$ nm

## **Amber Color Range**

	Min	Max				
Bin	Dom	Dom	Xmin	Ymin	Xmax	Ymax
2	587	589.5	0.5570	0.4420	0.5670	0.4250
			0.5530	0.4400	0.5720	0.4270
4	589.5	592	0.5720	0.4270	0.5820	0.4110
			0.5670	0.4250	0.5870	0.4130
6	592	594.5	0.5870	0.4130	0.5950	0.3980
			0.5820	0.4110	0.6000	0.3990

Tolerance for each bin limit is  $\pm 0.5$ nm

## **Red Orange Color Range**

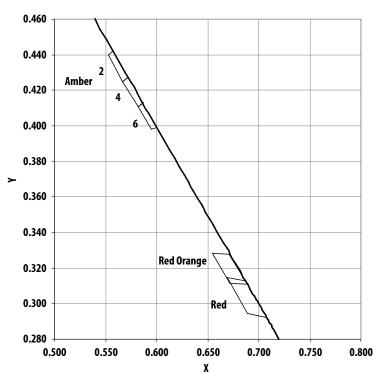
Min Dom	Max Dom	Xmin	Ymin	Xmax	Ymax
612	619	0.6712	0.6887	0.6716	0.6549
		0.3280	0.3109	0.3116	0.3282

Tolerance for each bin limit ± 0.5nm

#### Note:

All bin categories are established for classification of products. Products may not be available in all bin categories. Please contact Avago representative for further information.

# Avago Color Bin on CIE 1931 Chromaticity Diagram



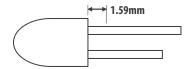
#### **Precautions:**

### **Lead Forming:**

- The leads of an LED lamp may be preformed or cut to length prior to insertion and soldering on PC board.
- For better control, it is recommended to use proper tool to precisely form and cut the leads to applicable length rather than doing it manually.
- If manual lead cutting is necessary, cut the leads after the soldering process. The solder connection forms a mechanical ground which prevents mechanical stress due to lead cutting from traveling into LED package. This is highly recommended for hand solder operation, as the excess lead length also acts as small heat sink.

#### **Soldering and Handling:**

- Care must be taken during PCB assembly and soldering process to prevent damage to the LED component.
- LED component may be effectively hand soldered to PCB. However, it is only recommended under unavoidable circumstances such as rework. The closest manual soldering distance of the soldering heat source (soldering iron's tip) to the body is 1.59mm. Soldering the LED using soldering iron tip closer than 1.59mm might damage the LED.



- ESD precaution must be properly applied on the soldering station and personnel to prevent ESD damage to the LED component that is ESD sensitive. Do refer to Avago application note AN 1142 for details. The soldering iron used should have grounded tip to ensure electrostatic charge is properly grounded.
- Recommended soldering condition:

	Wave Soldering [1, 2]	Manual Solder Dipping
Pre-heat temperature	105 °C Max.	-
Preheat time	60 sec Max	-
Peak temperature	260 °C Max.	260 °C Max.
Dwell time	5 sec Max.	5 sec Max

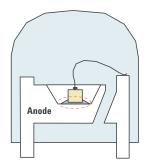
#### Note:

- Above conditions refers to measurement with thermocouple mounted at the bottom of PCB.
- It is recommended to use only bottom preheaters in order to reduce thermal stress experienced by LED.
- Wave soldering parameters must be set and maintained according to the recommended temperature and dwell time. Customer is advised to perform daily check on the soldering profile to ensure that it is always conforming to recommended soldering conditions.

#### Note:

- PCB with different size and design (component density) will have different heat mass (heat capacity). This might cause a change in temperature experienced by the board if same wave soldering setting is used. So, it is recommended to re-calibrate the soldering profile again before loading a new type of PCB.
- 2. Avago Technologies' high brightness LED are using high efficiency LED die with single wire bond as shown below. Customer is advised to take extra precaution during wave soldering to ensure that the maximum wave temperature does not exceed 260°C and the solder contact time does not exceeding 5sec. Over-stressing the LED during soldering process might cause premature failure to the LED due to delamination.

### **Avago Technologies LED Configuration**



Note: Electrical connection between bottom surface of LED die and the lead frame is achieved through conductive paste.

 Any alignment fixture that is being applied during wave soldering should be loosely fitted and should not apply weight or force on LED. Non metal material is recommended as it will absorb less heat during wave soldering process.

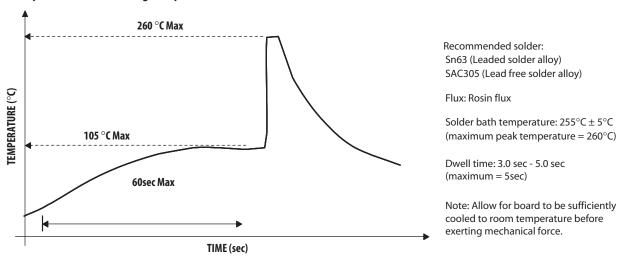
Note: In order to further assist customer in designing jig accurately that fit Avago Technologies' product, 3D model of the product is available upon request.

- At elevated temperature, LED is more susceptible to mechanical stress. Therefore, PCB must allowed to cool down to room temperature prior to handling, which includes removal of alignment fixture or pallet.
- If PCB board contains both through hole (TH) LED and other surface mount components, it is recommended that surface mount components be soldered on the top side of the PCB. If surface mount need to be on the bottom side, these components should be soldered using reflow soldering prior to insertion the TH LED.
- Recommended PC board plated through holes (PTH) size for LED component leads.

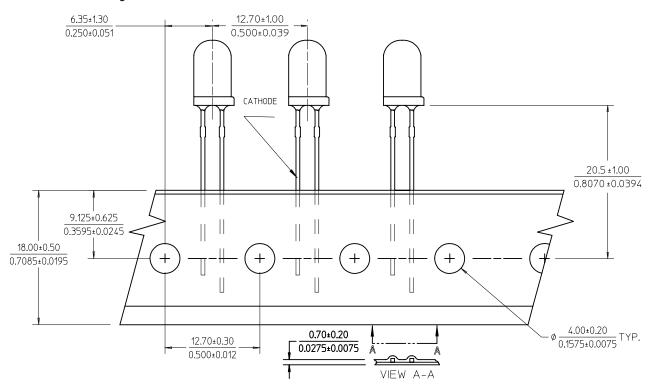
LED component		Plated through
lead size	Diagonal	hole diameter
0.45 x 0.45 mm	0.636 mm	0.98 to 1.08 mm
(0.018x 0.018 inch)	(0.025 inch)	(0.039 to 0.043 inch)
0.50 x 0.50 mm	0.707 mm	1.05 to 1.15 mm
(0.020x 0.020 inch)	(0.028 inch)	(0.041 to 0.045 inch)

 Over-sizing the PTH can lead to twisted LED after clinching. On the other hand under sizing the PTH can cause difficulty inserting the TH LED. Refer to application note AN5334 for more information about soldering and handling of high brightness TH LED lamps.

# **Example of Wave Soldering Temperature Profile for TH LED**

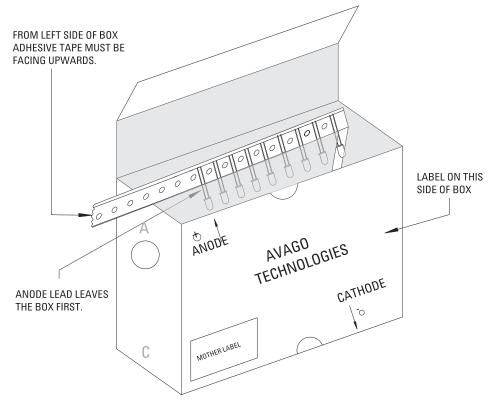


# **Ammo Packs Drawing**



Note: The ammo-packs drawing is applicable for packaging option -DD & -ZZ and regardless standoff or non-standoff

## **Packaging Box for Ammo Packs**



Note: The dimension for ammo pack is applicable for the device with standoff and without standoff.

# **Packaging Label:**

(i) Avago Mother Label: (Available on packaging box of ammo pack and shipping box)



### (ii) Avago Baby Label (Only available on bulk packaging)

**RoHS Compliant Lamps Baby Label** e3 max temp 260C (1P) PART #: Part Number (1T) LOT #: Lot Number (9D)MFG DATE: Manufacturing Date QUANTITY: Packing Quantity C/O: Country of Origin CAT: Intensity Bin Customer P/N: Ш Ш Supplier Code: BIN: Refer to below information Ш Ш DATECODE: Date Code 

## **Acronyms and Definition:**

BIN:

(i) Color bin only or VF bin only

(Applicable for part number with color bins but without VF bin OR part number with VF bins and no color bin)

OR

(ii) Color bin incorporated with VF Bin

(Applicable for part number that have both color bin and VF bin)

## Example:

(i) Color bin only or VF bin only

BIN: 2 (represent color bin 2 only)

BIN: VB (represent VF bin "VB" only)

(ii) Color bin incorporate with VF Bin



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